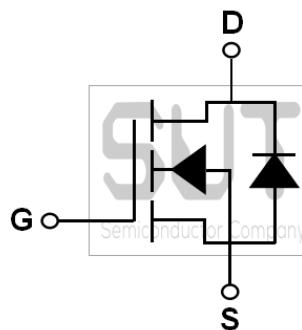
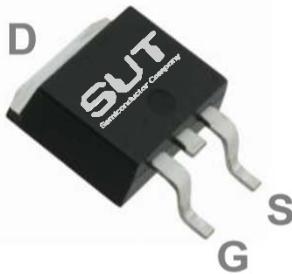


N-Channel 30-V_(D-S) MOSFET

PRODUCT SUMMARY		
B _{VDS} (V)	R _{DS(on)} (mΩ)(MAX)	I _D (A)
30	3.8@V _{GS} =10V	80

TO252 Pin Configuration



ABSOLUTE MAXIMUM RATINGS(T_C=25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous (T _C =25°C)	I _D	80	A
Drain Current-Continuous (T _C =100°C)		51	A
Drain Current-Pulsed ¹	I _{DM}	320	A
Single Pulse Avalanche Energy ²	EAS	125	mJ
Single Pulse Avalanche Current ²	I _{AS}	50	A
Power Dissipation (T _C =25°C)	P _D	66	W
Power Dissipation-Derate above 25°C		0.53	W/°C
Storage Temperature Range	T _{STG}	-55 to 175	°C
Operating Junction Temperature Range	T _J	-55 to 175	°C

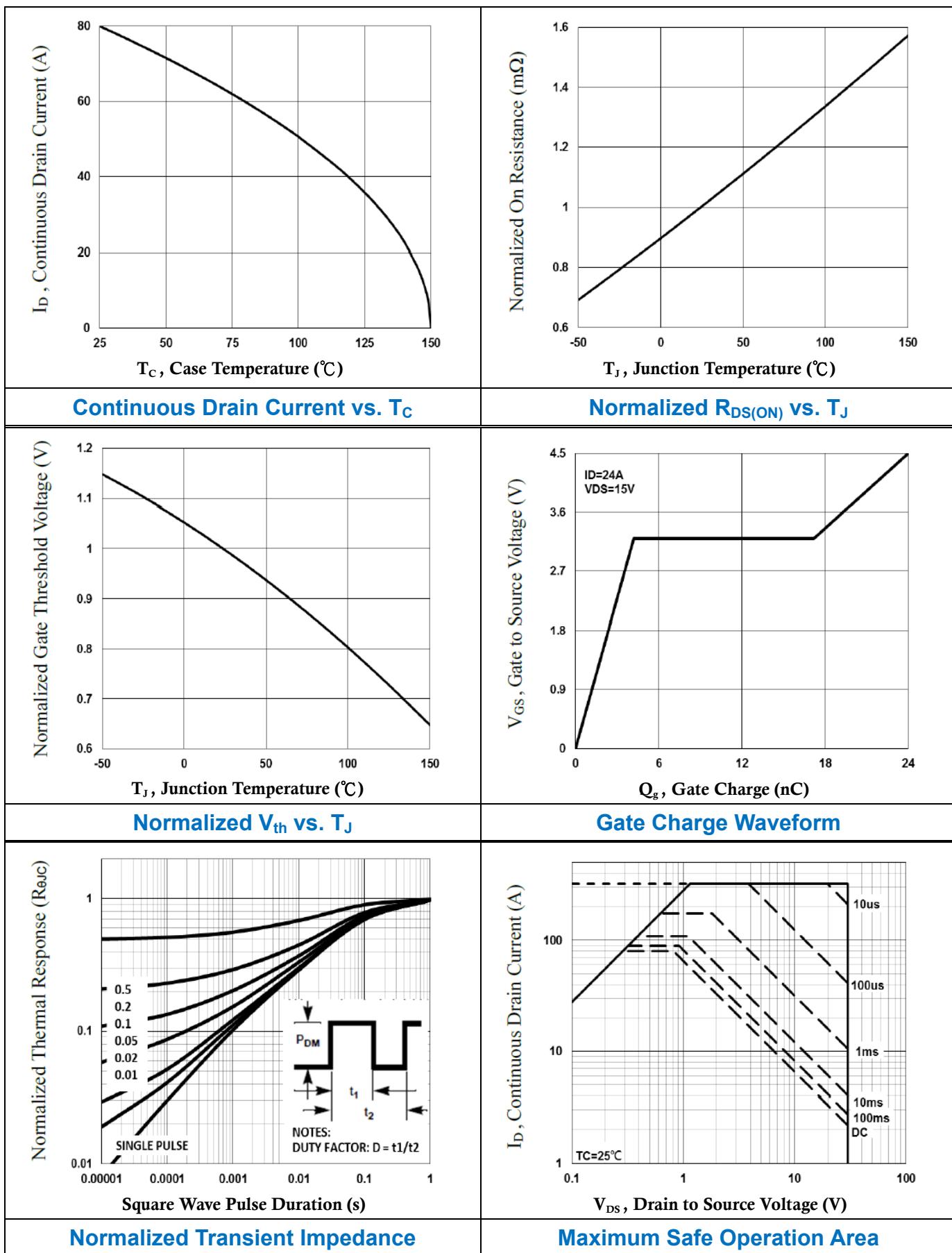
THERMAL CHARACTERISTICS

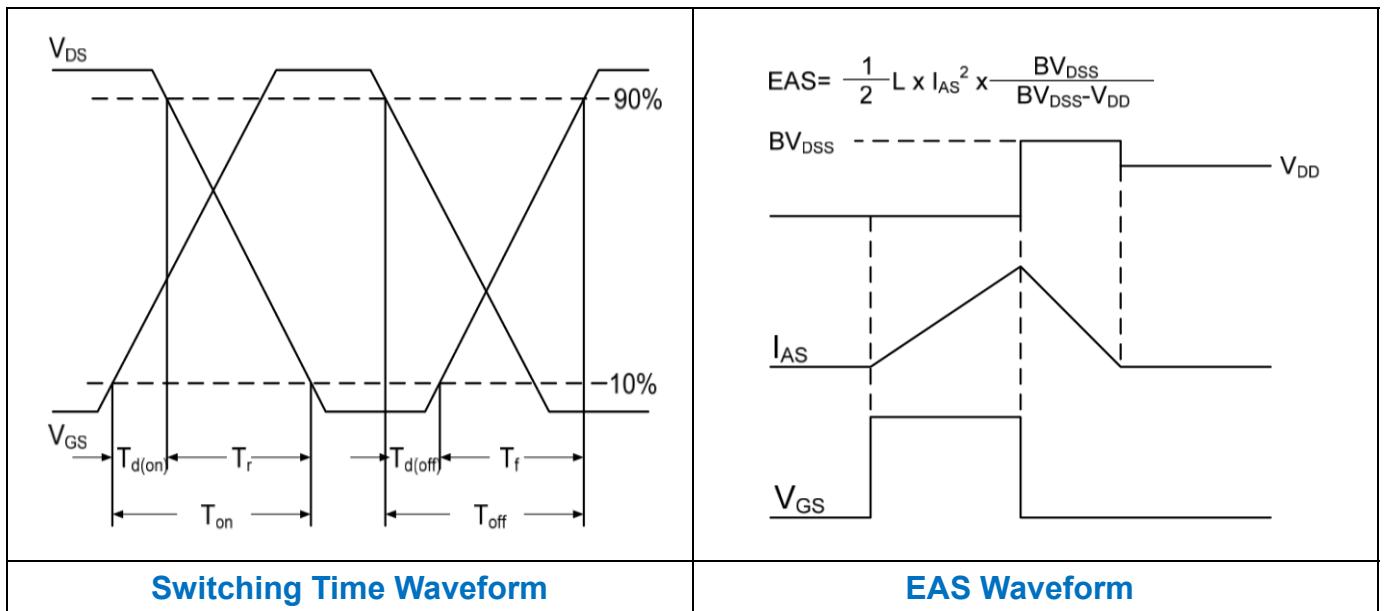
Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to ambient	R _{θJA}	---	62	°C/W
Thermal Resistance Junction to Case	R _{θJC}	---	2.0	°C/W

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static State Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	30	---	---	V
BV_{DSS} Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Reference to 25°C , $I_D=1\text{mA}$	---	0.03	---	$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=30\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=24\text{V}$, $T_J=125^\circ\text{C}$	---	---	10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
Static Drain-Source On-Resistance ³	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}$, $I_D=24\text{A}$	---	2.9	3.8	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_D=12\text{A}$	---	4.3	5.5	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	1.2	1.6	2.5	V
$V_{\text{GS(th)}}$ Temperature Coefficient	$\Delta V_{\text{GS(th)}}$		---	-5.0	---	$\text{mV}/^\circ\text{C}$
Forward Transconductance	g_{fs}	$V_{\text{DS}}=10\text{V}$, $I_D=10\text{A}$	---	28	---	S
Dynamic and Switching Characteristics						
Total Gate Charge ^{3, 4}	Q_g	$V_{\text{GS}}=4.5\text{V}$, $V_{\text{DS}}=15\text{V}$, $I_D=24\text{A}$	---	24	34	nC
Gate-Source Charge ^{3, 4}	Q_{gs}		---	4.2	6.0	
Gate-Drain Charge ^{3, 4}	Q_{gd}		---	13	18	
Turn-On Delay Time ^{3, 4}	$T_{\text{d(on)}}$	$V_{\text{GS}}=10\text{V}$, $V_{\text{DD}}=15\text{V}$, $R_G=3.3\Omega$, $I_D=15\text{A}$	---	12.6	24	ns
Rise Time ^{3, 4}	T_r		---	19.5	37	
Turn-Off Delay Time ^{3, 4}	$T_{\text{d(off)}}$		---	42.8	81	
Fall Time ^{3, 4}	T_f		---	13.2	25	
Input Capacitance	C_{iss}	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=25\text{V}$, $F=1\text{MHz}$	---	2200	3190	pF
Output Capacitance	C_{oss}		---	280	405	
Reverse Transfer Capacitance	C_{rss}		---	177	255	
Gate resistance	R_g	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $F=1\text{MHz}$	---	2.0	4.0	Ω
Guaranteed Avalanche Energy						
Single Pulse Avalanche Energy	EAS	$V_{\text{DD}}=25\text{V}$, $L=0.1\text{mH}$, $I_{\text{AS}}=24\text{A}$	31	---	---	mJ
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I_S	$V_G=V_D=0\text{V}$, Force Current	---	---	80	A
Pulsed Source Current ³	I_{SM}		---	---	320	A
Diode Forward Voltage ³	V_{SD}	$V_{\text{GS}}=0\text{V}$, $I_S=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1.0	V
Reverse Recovery Time	t_{rr}	$V_{\text{GS}}=0\text{V}$, $I_S=1\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	---	---	ns
Reverse Recovery Charge	Q_{rr}		---	---	---	nC

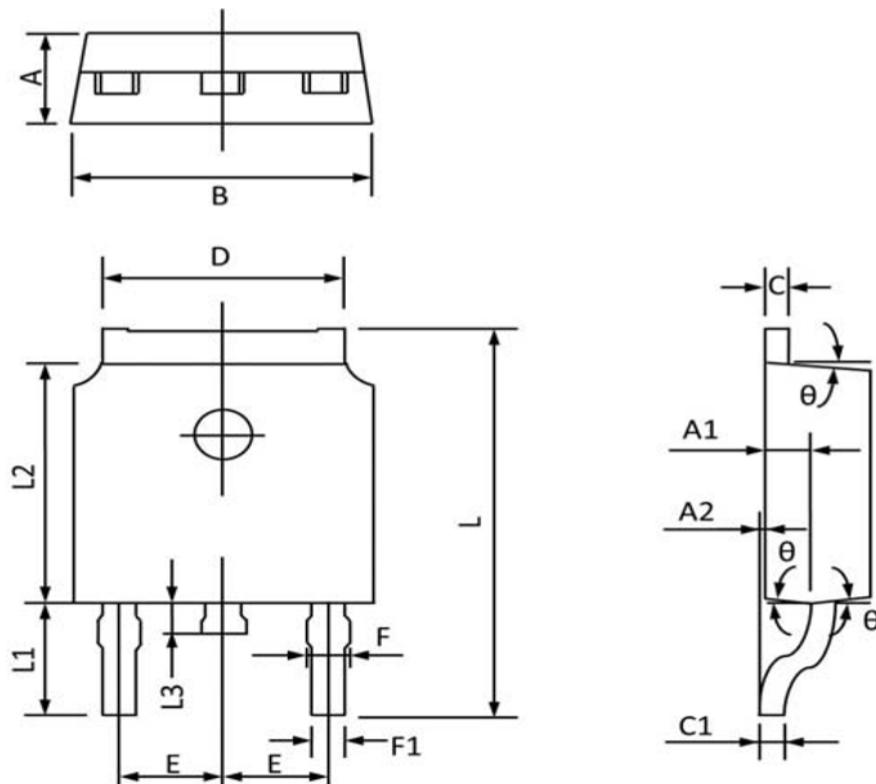
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{\text{GS}}=10\text{V}$, $V_{\text{DD}}=25\text{V}$, $L=0.1\text{mH}$, $I_{\text{AS}}=50\text{A}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.
3. The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.





TO252 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.400	2.200	0.094	0.087
A1	1.110	0.910	0.044	0.036
A2	0.150	0.000	0.006	0.000
B	6.800	6.400	0.268	0.252
C	0.580	0.450	0.023	0.018
C1	0.580	0.460	0.023	0.018
D	5.500	5.100	0.217	0.201
E	2.386	2.186	0.094	0.086
F	0.940	0.600	0.037	0.024
F1	0.860	0.500	0.034	0.020
L	10.400	9.400	0.409	0.370
L1	3.000	2.400	0.118	0.094
L2	6.200	5.400	0.244	0.213
L3	1.200	0.600	0.047	0.024
θ	9°	3°	9°	3°